

SN54AHC16540, SN74AHC16540

16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCLS331F – MARCH 1996 – REVISED JANUARY 2000

- **Members of the Texas Instruments Widebus™ Family**
- **EPIC™ (Enhanced-Performance Implanted CMOS) Process**
- **Operating Range 2-V to 5.5-V V_{CC}**
- **Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise**
- **Flow-Through Architecture Optimizes PCB Layout**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015**
- **Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

description

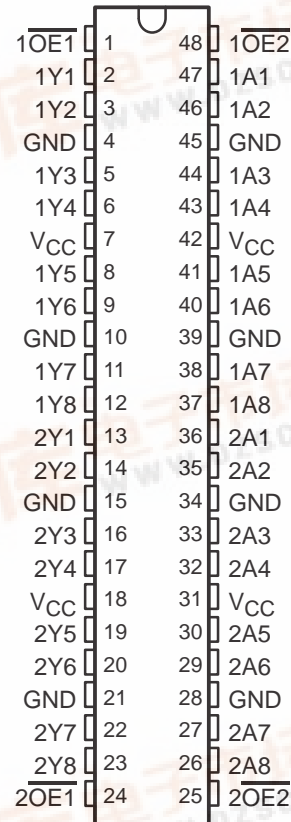
These 16-bit buffers and bus drivers provide a high-performance bus interface for wide data paths.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable ($\overline{OE1}$ or $\overline{OE2}$) input is high, all corresponding outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54AHC16540 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AHC16540 is characterized for operation from -40°C to 85°C .

SN54AHC16540 ... WD PACKAGE
SN74AHC16540 ... DGG, DGV, OR DL PACKAGE
(TOP VIEW)



FUNCTION TABLE
(each 8-bit buffer/driver)

INPUTS			OUTPUT Y
$\overline{OE1}$	$\overline{OE2}$	A	
L	L	L	H
L	L	H	L
H	X	X	Z
X	H	X	Z

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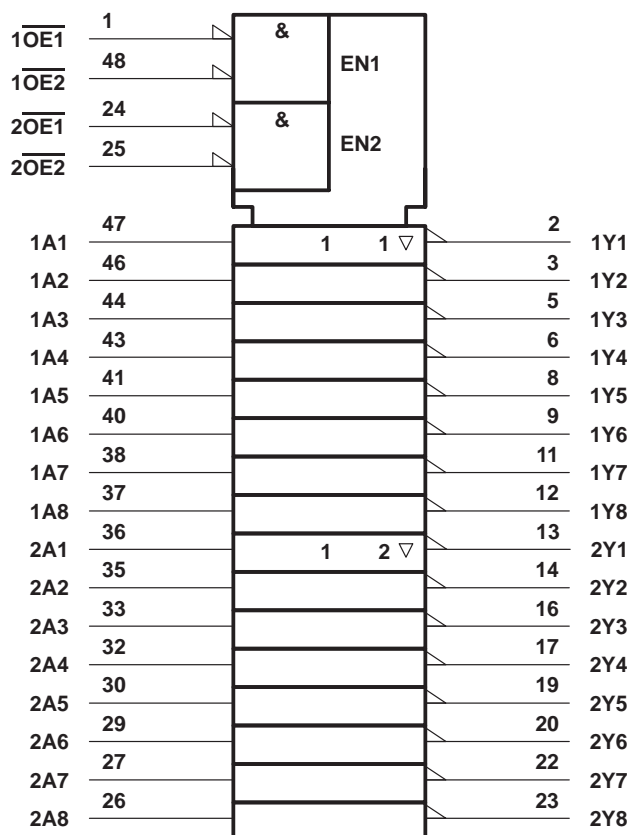
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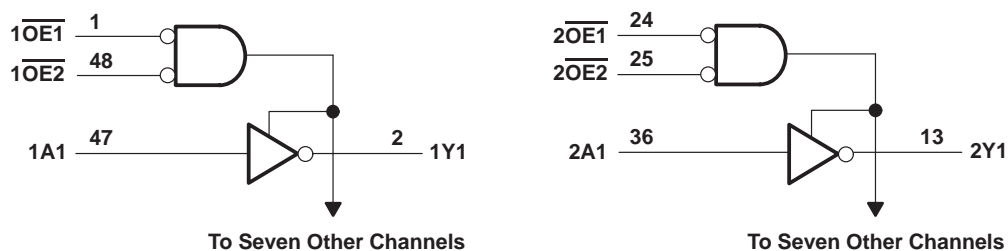
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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Supply voltage range, V_{CC}	-0.5 V to 7 V
Input voltage range, V_I (see Note 1)	-0.5 V to 7 V
Output voltage range, V_O (see Note 1)	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	-20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	± 20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	± 25 mA
Continuous current through each V_{CC} or GND	± 75 mA
Package thermal impedance, θ_{JA} (see Note 2):		
	DGG package	70°C/W
	DGV package	58°C/W
	DL package	63°C/W
Storage temperature range, T_{stg}	-65°C to 150°C

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JEDEC 51.

			SN54AHC16540		SN74AHC16540		UNIT
			MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage		2	5.5	2	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 2 V	1.5		1.5		V
		V _{CC} = 3 V	2.1		2.1		
		V _{CC} = 5.5 V	3.85		3.85		
V _{IL}	Low-level input voltage	V _{CC} = 2 V		0.5		0.5	V
		V _{CC} = 3 V		0.9		0.9	
		V _{CC} = 5.5 V		1.65		1.65	
V _I	Input voltage		0	5.5	0	5.5	V
V _O	Output voltage		0	V _{CC}	0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 2 V		−50		−50	μA
		V _{CC} = 3.3 V ± 0.3 V		−4		−4	mA
		V _{CC} = 5 V ± 0.5 V		−8		−8	
I _{OL}	Low-level output current	V _{CC} = 2 V		50		50	μA
		V _{CC} = 3.3 V ± 0.3 V		4		4	mA
		V _{CC} = 5 V ± 0.5 V		8		8	
Δt/Δv	Input transition rise or fall rate	V _{CC} = 3.3 V ± 0.3 V		100		100	ns/V
		V _{CC} = 5 V ± 0.5 V		20		20	
T _A	Operating free-air temperature		−55	125	−40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54AHC16540		SN74AHC16540		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}	I _{OH} = -50 µA	2 V	1.9	2		1.9		1.9		V
		3 V	2.9	3		2.9		2.9		
		4.5 V	4.4	4.5		4.4		4.4		
	I _{OH} = -4 mA	3 V	2.58			2.48		2.48		
	I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8		
V _{OL}	I _{OL} = 50 µA	2 V			0.1		0.1		0.1	V
		3 V			0.1		0.1		0.1	
		4.5 V			0.1		0.1		0.1	
	I _{OL} = 4 mA	3 V			0.36		0.5		0.44	
	I _{OL} = 8 mA	4.5 V			0.36		0.5		0.44	
I _I	V _I = V _{CC} or GND	0 V to 5.5 V			±0.1		±1*		±1	µA
I _{OZ}	V _O = V _{CC} or GND, V _I (OE) = V _{IL} or V _{IH}	5.5 V			±0.25		±2.5		±2.5	µA
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V			4		40		40	µA
C _i	V _I = V _{CC} or GND	5 V		2	10				10	pF
C _o	V _O = V _{CC} or GND	5 V		3						pF

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T _A = 25°C			SN54AHC16540		SN74AHC16540		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A	Y	C _L = 15 pF		4.8**	8.4**	1**	10**	1	10	ns
t _{PHL}					4.8**	8.4**	1**	10**	1	10	
t _{PZH}	$\overline{\text{OE}}$	Y	C _L = 15 pF		6.8**	10.6**	1**	12.5**	1	12.5	ns
t _{PZL}					6.8**	10.6**	1**	12.5**	1	12.5	
t _{PHZ}	$\overline{\text{OE}}$	Y	C _L = 15 pF		6.8**	11.5**	1**	12.5**	1	12.5	ns
t _{PLZ}					6.8**	11.5**	1**	12.5**	1	12.5	
t _{PLH}	A	Y	C _L = 50 pF		7.7	11	1	12.5	1	12.5	ns
t _{PHL}					7.3	11	1	12.5	1	12.5	
t _{PZH}	$\overline{\text{OE}}$	Y	C _L = 50 pF		9.7	14.1	1	16	1	16	ns
t _{PZL}					7.1	14.1	1	16	1	16	
t _{PHZ}	$\overline{\text{OE}}$	Y	C _L = 50 pF		9.4	14	1	16	1	16	ns
t _{PLZ}					9.7	14	1	16	1	16	
t _{sk(o)}			C _L = 50 pF			1.5***				1.5	ns

** On products compliant to MIL-PRF-38535, this parameter is not production tested.

*** On products compliant to MIL-PRF-38535, this parameter does not apply.

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54AHC16540		SN74AHC16540		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A	Y	$C_L = 15\text{ pF}$		3.7*	6*	1*	7*	1	7	ns
t_{PHL}					3.7*	6*	1*	7*	1	7	
t_{PZH}	\overline{OE}	Y	$C_L = 15\text{ pF}$		4.7*	7.3*	1*	8.5*	1	8.5	ns
t_{PZL}					4.7*	7.3*	1*	8.5*	1	8.5	
t_{PHZ}	\overline{OE}	Y	$C_L = 15\text{ pF}$		4.5*	7.2*	1*	8.5*	1	8.5	ns
t_{PLZ}					4.5*	7.2*	1*	8.5*	1	8.5	
t_{PLH}	A	Y	$C_L = 50\text{ pF}$		5.2	8	1	9	1	8.5	ns
t_{PHL}					5.2	8	1	9	1	8.5	
t_{PZH}	\overline{OE}	Y	$C_L = 50\text{ pF}$		6.2	9.3	1	10.5	1	10.5	ns
t_{PZL}					6.2	9.3	1	10.5	1	10.5	
t_{PHZ}	\overline{OE}	Y	$C_L = 50\text{ pF}$		6	9.2	1	10.5	1	10.5	ns
t_{PLZ}					6	9.2	1	10.5	1	10.5	
$t_{sk(o)}$			$C_L = 50\text{ pF}$			1**				1	ns

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

** On products compliant to MIL-PRF-38535, this parameter does not apply.

noise characteristics, $V_{CC} = 5\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 4)

PARAMETER		SN74AHC16540			UNIT
		MIN	TYP	MAX	
$V_{OL(P)}$	Quiet output, maximum dynamic V_{OL}		0.6		V
$V_{OL(V)}$	Quiet output, minimum dynamic V_{OL}		-0.3		V
$V_{OH(V)}$	Quiet output, minimum dynamic V_{OH}		4.7		V
$V_{IH(D)}$	High-level dynamic input voltage		3.5		V
$V_{IL(D)}$	Low-level dynamic input voltage			1.5	V

NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance	No load, $f = 1\text{ MHz}$	13	pF

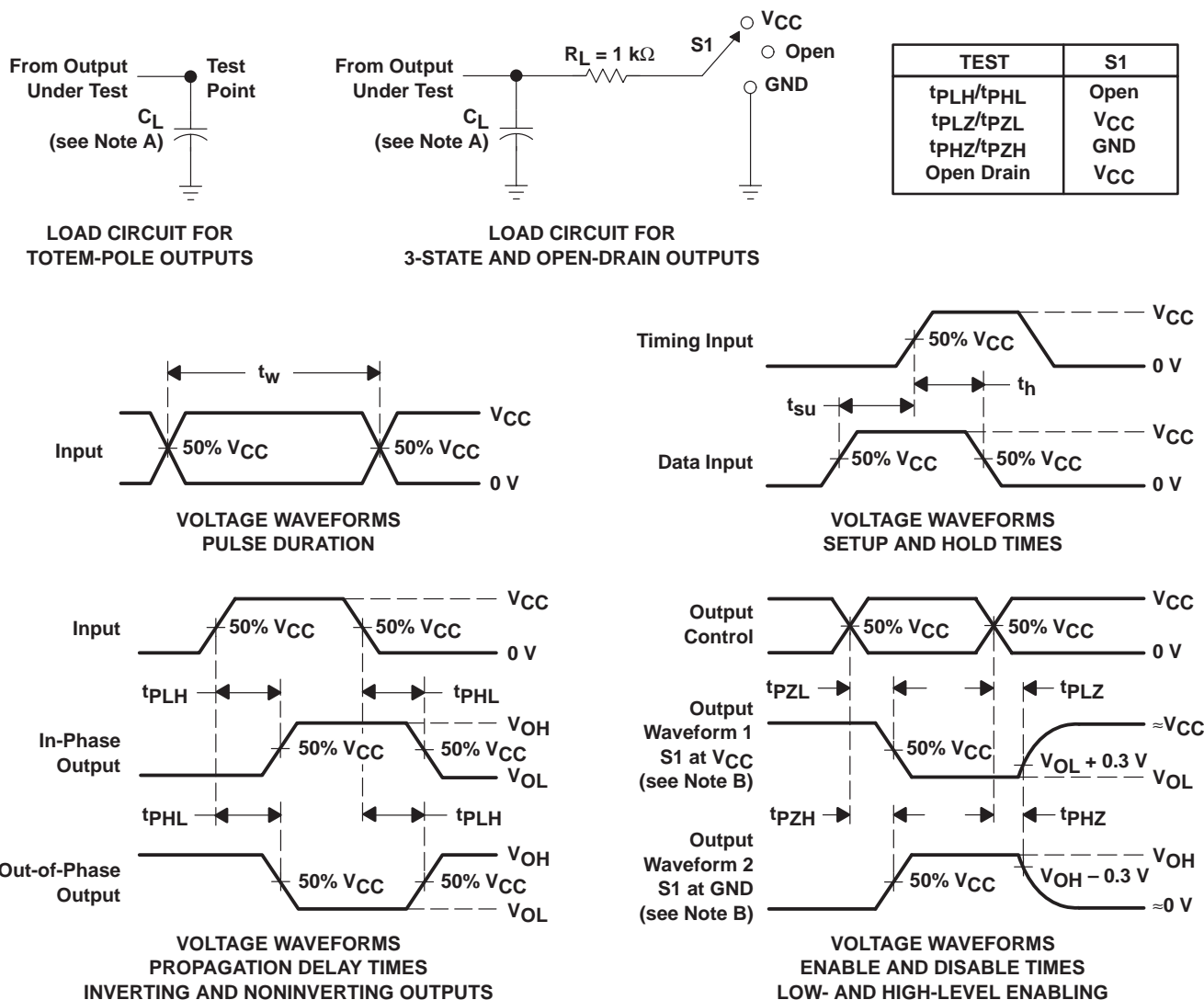
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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 - The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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